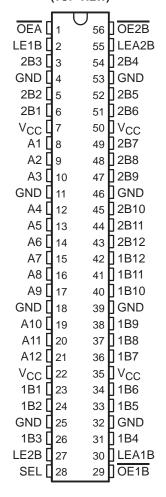
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- **Members of the Texas Instruments** Widebus™ Family
- State-of-the-Art *EPIC-IIB™* BiCMOS Design Significantly Reduces Power Dissipation
- **ESD Protection Exceeds 2000 V Per** MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per **JEDEC Standard JESD-17**
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5 \text{ V}, T_A = 25^{\circ}\text{C}$
- **High-Impedance State During Power Up** and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OL})
- Bus Hold on Data Inputs Eliminates the **Need for External Pullup/Pulldown Resistors**
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Package and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center **Spacings**

description

The SN54ABT16260 and SN74ABTH16260 are 12-bit to 24-bit multiplexed D-type latches used in applications in which two separate data paths must be multiplexed onto, or demultiplexed from, a single data path. Typical applications include multiplexing and/or demultiplexing of address and information in microprocessor bus-interface applications. This device is also useful in memory-interleaving applications.

SN54ABT16260 . . . WD PACKAGE SN74ABTH16260 . . . DL PACKAGE (TOP VIEW)



Three 12-bit I/O ports (A1-A12, 1B1-1B12, and 2B1-2B12) are available for address and/or data transfer. The output-enable (OE1B, OE2B, and OEA) inputs control the bus-transceiver functions. The OE1B and OE2B control signals also allow bank control in the A-to-B direction.

Address and/or data information can be stored using the internal storage latches. The latch-enable (LE1B, LE2B, LEA1B, and LEA2B) inputs are used to control data storage. When the latch-enable input is high, the latch is transparent. When the latch-enable input goes low, the data present at the inputs is latched and remains latched until the latch-enable input is returned high.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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description (continued)

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN54ABT16260 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABTH16260 is characterized for operation from -40°C to 85°C.

Function Tables

B TO A ($\overline{OEB} = H$)

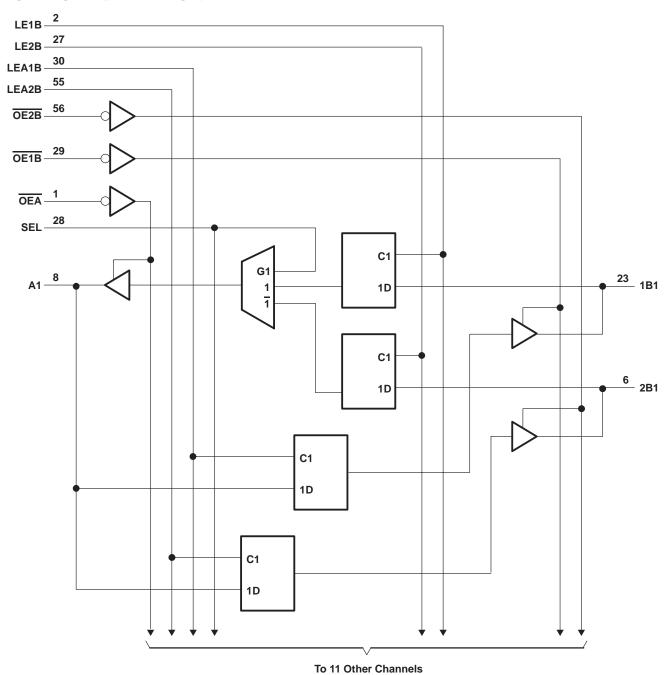
	INPUTS												
1B	2B	SEL	LE1B	LE2B	OEA	Α							
Н	Χ	Н	Н	Х	L	Н							
L	Χ	Н	Н	X	L	L							
Х	Χ	Н	L	X	L	A ₀							
Х	Н	L	X	Н	L	Н							
Х	L	L	X	Н	L	L							
Х	Χ	L	X	L	L	A ₀							
Х	Χ	Χ	Χ	X	Н	Z							

A TO B ($\overline{OEA} = H$)

		INPUTS			OUTI	PUTS
Α	LEA1B	LEA2B	OE1B	OE2B	1B	2B
Н	Н	Н	L	L	Н	Н
L	Н	Н	L	L	L	L
Н	Н	L	L	L	Н	2B ₀
L	Н	L	L	L	L	2B ₀
Н	L	Н	L	L	1B ₀	Н
L	L	Н	L	L	1B ₀	L
Х	L	L	L	L	1B ₀	2B ₀
Х	X	Χ	Н	Н	Z	Z
Х	Χ	Χ	L	Н	Active	Z
Х	Χ	Χ	Н	L	Z	Active
Х	X	Χ	L	L	Active	Active

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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	
Voltage range applied to any output in the high or power-off state, VO	0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABT16260	96 mA
SN74ABTH16260	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	–18 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Package thermal impedance, θ _{JA} (see Note 2): DL package	74°C/W
Storage temperature range, T _{stq}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

			SN54AB1	16260	SN74ABTI	116260	UNIT
			MIN	MAX	MIN	MAX	UNII
VCC	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage		2		2		V
V _{IL}	Low-level input voltage			0.8		0.8	V
VI	Input voltage		0	Vcc	0	VCC	V
loн	High-level output current			-24		-32	mA
loL	Low-level output current			48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
Δt/ΔV _{CC}	Power-up ramp rate		200		200		μs/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused control inputs must be held high or low to prevent them from floating.



NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAD	AMETER	TEST CON	DITIONS	Т	A = 25°C	;	SN54AB	Г16260	SN74ABTI	H16260	UNIT
PAR	AMETER	TEST CON	CNOILIG	MIN	TYP†	MAX	MIN	MAX	MIN	MAX	UNII
٧ıK		$V_{CC} = 4.5 \text{ V},$	$I_{I} = -18 \text{ mA}$			-1.2		-1.2		-1.2	V
		$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ mA}$	2.5			2.5		2.5		
\/~		$V_{CC} = 5 \text{ V}, \qquad I_{OH} = -3 \text{ mA}$		3			3		3		V
VOH		V _{CC} = 4.5 V	I _{OH} = -24 mA	2			2				V
		VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$	2*					2		
VoL		V _{CC} = 4.5 V	I _{OL} = 48 mA		0.36			0.5			V
VOL		VCC = 4.5 V	I _{OL} = 64 mA			0.55*				0.55	V
V _{hys}					100						mV
1.	Control inputs	$V_{CC} = 0$ to 5.5 V, $V_{I} = V_{CC}$ or GND				±1		±1		±1	A
l _l	A or B ports	$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V}$ $V_I = V_{CC} \text{ or GND}$	/,			±20		±100		±20	μΑ
L	A == D == ===	V 45V	V _I = 0.8 V				100		100		^
l(hold)	A or B ports	VCC = 4.5 V	V _I = 2 V				-100		-100		μΑ
lozpu [‡]		$V_{CC} = 0 \text{ to } 2.1 \text{ V},$ $V_{O} = 0.5 \text{ V to } 2.7 \text{ V},$	OE = X			±50		±50		±50	μΑ
lozpD [‡]		$V_{CC} = 2.1 \text{ V to 0},$ $V_{O} = 0.5 \text{ V to 2.7 V},$	OE = X			±50		±50		±50	μΑ
IOZH§		$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V}$ $V_{O} = 2.7 \text{ V}, \overline{OE} \ge 2 \text{ V}$				10		10		10	μΑ
I _{OZL} §		$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V}$ $V_{O} = 0.5 \text{ V}, \overline{OE} \ge 2 \text{ V}$	/, /			-10		-10		-10	μΑ
l _{off}		$V_{CC} = 0$,	V_I or $V_O \le 4.5 \text{ V}$			±100				±100	μΑ
ICEX		V _{CC} = 5.5 V, V _O = 5.5 V	Outputs high			50		50		50	μΑ
ΙΟ [¶]		V _{CC} = 5.5 V,	V _O = 2.5 V	-50	-100	-225	-50	-225	-50	-225	mA
		V _{CC} = 5.5 V,	Outputs high			1.5		1.5		1.5	
ICC		$I_{O} = 0$,	Outputs low			63		63		63	mA
		$V_I = V_{CC}$ or GND	Outputs disabled			1		1		1	
ΔICC#		V_{CC} = 5.5 V, One in Other inputs at V_{CC}				1.5		1.5		1.5	mA
Ci	V _I = 2.5 V or 0.5 V			3						pF	
C _{io}					11.5						pF

^{*} On products compliant to MIL-PRF-38535, this parameter does not apply.



[†] All typical values are at $V_{CC} = 5 \text{ V}$.

[‡] This parameter is characterized, but not production tested.

[§] The parameters IOZH and IOZL include the input leakage current.

[¶] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[#] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

		V _{CC} = T _A = 2	= 5 V, 25°C†	SN54AB1	Г16260	SN74ABTI	116260	UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
t _W	Pulse duration, LE1B, LE2B, LEA1B, or LEA2B high	3.3		3.3		3.3		ns
t _{su}	Setup time, data before LE1B, LE2B, LEA1B, or LEA2B↓	1.5		2		1.5		ns
th	Hold time, data after LE1B, LE2B, LEA1B, or LEA2B↓	1		1.5		1		ns

[†] These values apply only to the SN74ABTH16260.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_1 = 50$ pF (unless otherwise noted) (see Figure 1)

				SN5	4ABT16	260		
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V ₍	CC = 5 V 4 = 25°C	<i>'</i> ,	MIN	MAX	UNIT
			MIN	TYP	MAX			
t _{PLH}	A or B	B or A	1	3.1	5.3	1	5.9	ns
^t PHL	AUID	BULA	1	3.4	5.4	1	6.3	115
^t PLH	1.5	A or B	1.1	3.2	5.4	1.1	6.6	ns
^t PHL	LE	AUIB	1.1	3.3	5.3	1.1	5.9	115
+	SEL (B1)		1.3	3.2	5.1	1.3	5.4	
^t PLH	SEL (B2)	A	1.1	3.4	5.4	1.1	6.3	ns
+	SEL (B1)	^	1.5	3.1	4.6	1.5	5	115
^t PHL	SEL (B2)		1.6	3.6	5.3	1.6	6.2	
^t PZH	ŌĒ	A or B	1	3.3	5.6	1	6.4	
tPZL	OE .	AUIB	1.6	3.8	5.9	1.6	6.5	ns
^t PHZ	ŌĒ	A or P	2.2	4.1	5.9	2.2	7.5	no
t _{PLZ}	OE	E A or B		3.2	5	1.3	5.4	⊣ ns

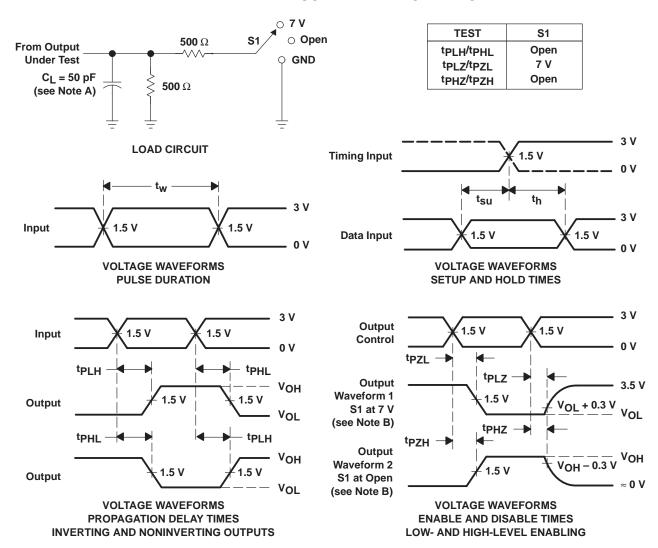
switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

				SN74	ABTH1	6260		
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V (CC = 5 V A = 25°C	<i>'</i> ,	MIN	MAX	UNIT
			MIN	TYP	MAX			
t _{PLH}	A or B	B or A	1	3.1	4.8	1	5.6	ns
t _{PHL}	AOID	BUIA	1	3.4	5	1	5.9	115
t _{PLH}		A or B	1.1	3.2	4.9	1.1	5.8	ns
tPHL	LE	AOIB	1.1	3.3	4.9	1.1	5.3	115
+ =	SEL (B1)		1.3	3.2	4.6	1.3	5.3	
tPLH	SEL (B2)	A	1.1	3.4	4.9	1.1	6	ns
+	SEL (B1)	^	1.5	3.1	4.4	1.5	4.4	115
t _{PHL}	SEL (B2)		1.6	3.6	5.1	1.6	5.9	
^t PZH		A or B	1	3.3	4.7	1	5.7	20
t _{PZL}	tPHZ OE	AUID	1.6	3.8	5.1	1.6	5.8	ns
tPHZ		A or B	2.2	4.1	5.4	2.2	6.4	ns
^t PLZ	OE	A or B		3.2	4.4	1.3	4.8	115



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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \ \Omega$, $t_f \leq 2.5 \ ns$, $t_f \leq 2.5 \ ns$.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



PACKAGE OPTION ADDENDUM

10-Dec-2020

PACKAGING INFORMATION

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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ABTH16260DL	ACTIVE	SSOP	DL	56	20	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABTH16260	Samples
SN74ABTH16260DLR	ACTIVE	SSOP	DL	56	1000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABTH16260	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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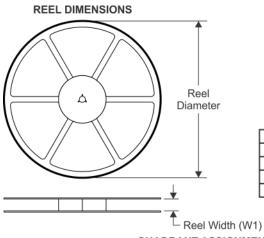


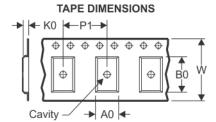
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PACKAGE MATERIALS INFORMATION

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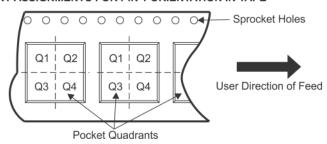
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

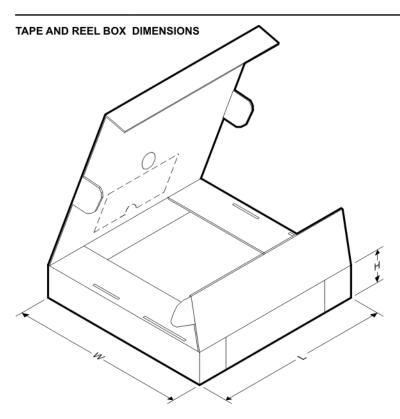
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABTH16260DLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABTH16260DLR	SSOP	DL	56	1000	367.0	367.0	55.0

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74ABTH16260DL	DL	SSOP	56	20	473.7	14.24	5110	7.87

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